

### CONSISTENCY IN CHANGE

Results FY 20/21

Conference Call

18 May 2021

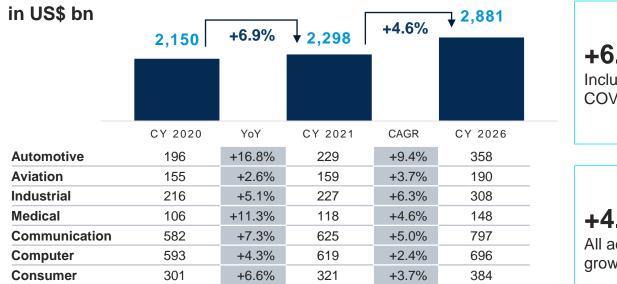
#### MARKET UPDATE

Andreas Gerstenmayer, CEO





### **GLOBAL ELECTRONIC SYSTEMS MARKET OUTLOOK**



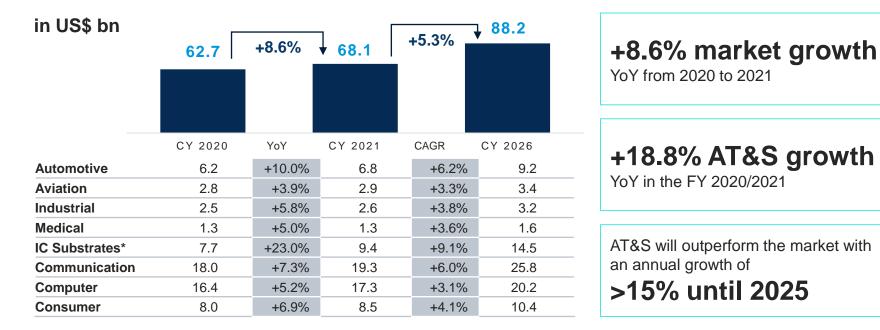
#### +6.9% YoY growth

Including catch-up effects after COVID-19 year 2020

#### +4.6% CAGR

All adressed markets show positive growth rates over the mid-term

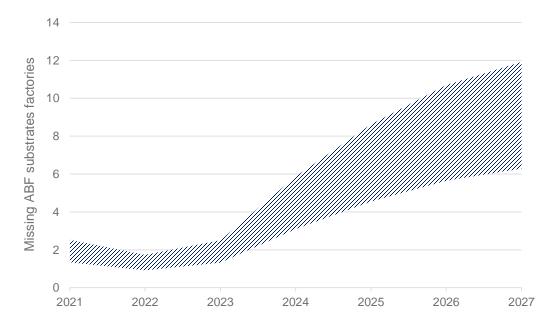
### AT&S OUTPERFORMS PCB & IC SUBSTRATES\* MARKET GROWTH





### **CONTINUOUS GROWTH IN ABF SUBSTRATES DEMAND**

Actual gap of required ABF substrates factories to satisfy demand



- Actual gap depends on actual mix in product and technology demand
- Increasing complexity of high-end products leads to ongoing strong ABF substrates demand
- Complexity requires increasing layer count and larger products
- Current supply shortage is predominantly in high-end products
- Especially server and Al applications drive the demand

# STRATEGIC BUSINESS DRIVERS





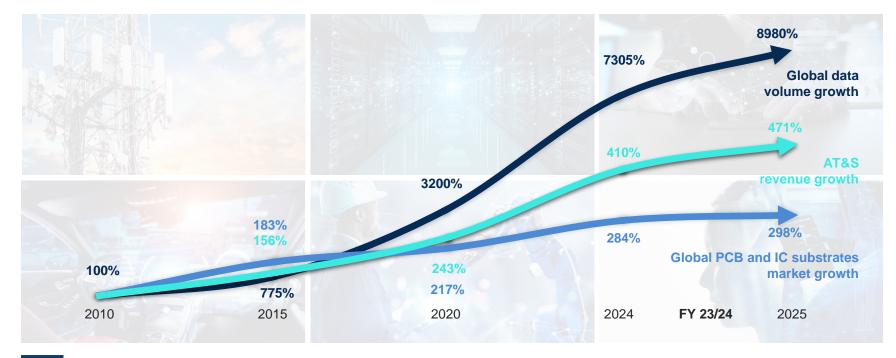
#### GAME CHANGERS ARE DRIVING OUR BUSINESS

New technologies and systems bring a significant data volume increase



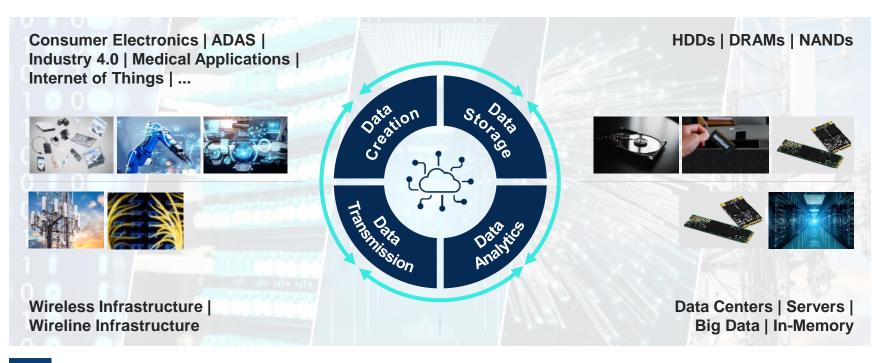


#### GLOBAL DATA VOLUME DEVELOPMENT DRIVES AT&S GROWTH





### **DIGITALISATION REQUIRES DATA MANAGEMENT**

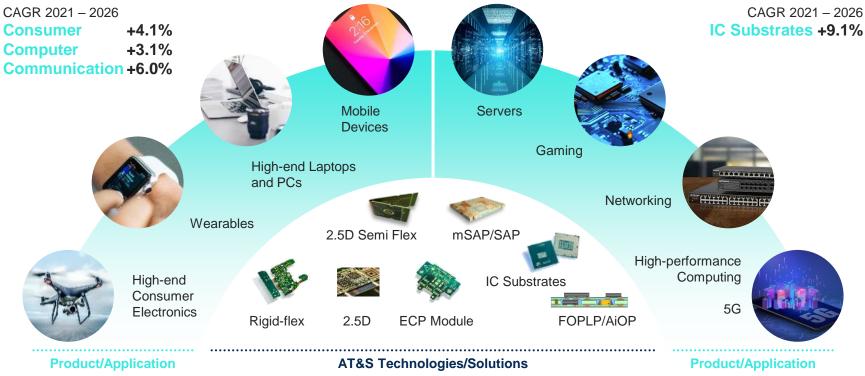




#### AT&S GROWTH ENABLED BY APPLICATIONS AND INNOVATION & SUSTAINABILITY

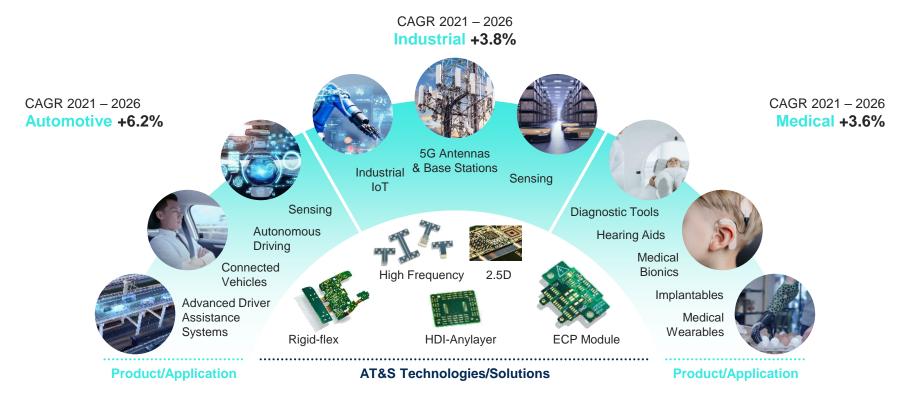


### **MOBILE DEVICES AND SUBSTRATES**



\* PCB/IC Substrates Market Growth: CAGR 2021-2026

### **AUTOMOTIVE – INDUSTRIAL – MEDICAL**



#### **R&D – BASIS FOR TECHNOLOGY LEADERSHIP**



Status: FY 2020/21

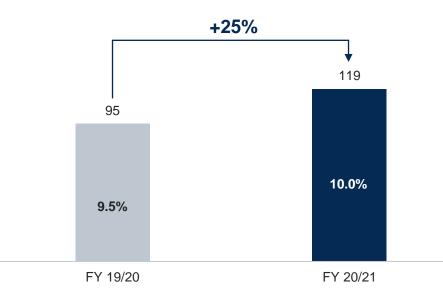
\*Share of revenue of technologically innovative products made in the last three years (previously: Innovation Revenue Rate)



### **R&D INVESTMENTS**

#### A key revenue and margin driver

in € mn



# € 246 mn revenue with new products

| Miniaturisation<br>and functional<br>integration | Fast signal transmission    |
|--|-----------------------------|
| Performance and performance efficiency           | Manufacturing of the future |



#### Highlights FY 20/21

| <b>45%</b><br>renewable energy   | Start of<br>life cycle<br>assessment   | <b>20%</b><br>women in<br>management positions | Rated by<br>MSCI<br>ESG RATINGS<br>CCC B BB BB A AAAA<br>COrporate ESG<br>Performance<br>Prime |
|--|--|--|--|
| ISO<br>9001, 45001,14001<br>at all production sites<br>ISO 50001<br>in Austria and India | <b>100%</b><br>of the main suppliers<br>confirm compliance with<br>the Code of Conduct | <b>100%</b><br>RMI supply chain<br>compliance  | E Marningstar company  |

### **KEY DEVELOPMENTS FY 20/21**

#### Strong full-year results demonstrate AT&S resilience and agility

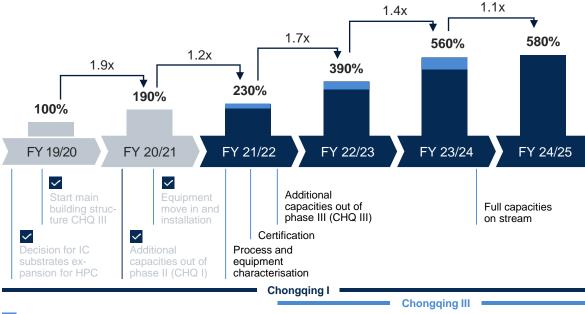
Growing profitably with served markets

- Additional capacities and strong demand drive ABF substrates business
- Mobile applications supported by customer and application diversification
- PCBs for modules contribute to overall revenue growth
- Automotive with ongoing recovery and Q4 above last year
- Medical & Healthcare with stable performance due to improved demand
- Industrial segment with positive development thanks to better product mix
- Capacity expansion in Chongqing faster than expected



### **RAMP OF CHONGQING III EARLIER THAN EXPECTED**

#### ABF substrates output capacity

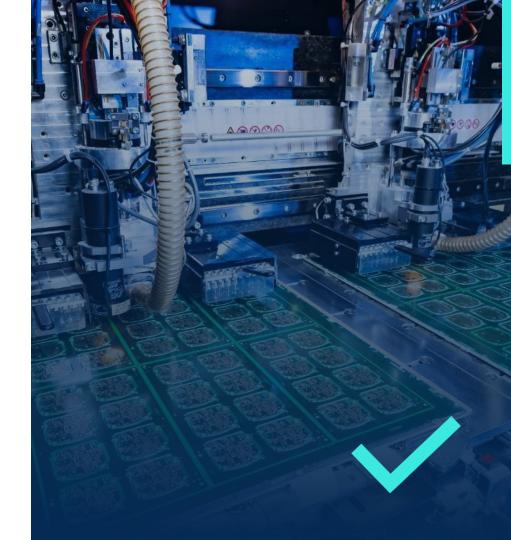


Additional output capacity due to investment increase and earlier production start in CHQ III

- CHQ III: Production will already be starting in FY 21/22
- Additional € 200 mn investment in CHQ III
- Full capacities available with the beginning of CY 2024 (Q4 23/24)

### WE PROMISE AND WE DELIVER

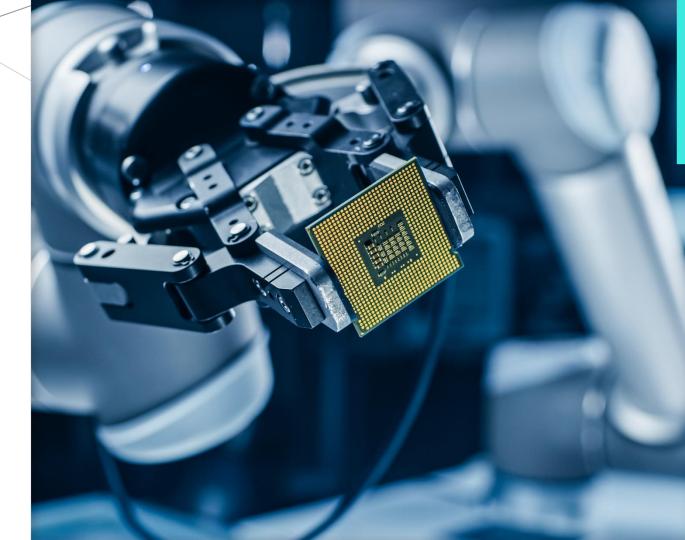
- We announced one billion in revenue: Achieved in FY 2018/19
- We announced the 2<sup>nd</sup> billion in revenue:
   We will achieve it one year earlier than planned
- We present AT&S as one of the top players in HDI printed circuit boards:
   Achieved – we have been among the top 3 for several years
- We are on our way to become one of the top players in ABF substrates:
   From #5 today to #3 in future
- We are transforming from a PCB manufacturer to an Interconnection Solutions Provider and enable future growth: Level 0 – High quality printed circuit boards Level 1 – Module business (Substrates, Module PCBs)
  - Level 2 Ongoing preparations to provide solutions for Complete Modules





#### **RESULTS FY 20/21**

Simone Faath, CFO





### FY 20/21 RESULTS SUMMARY

#### Revenue at historic high

Revenue +19%

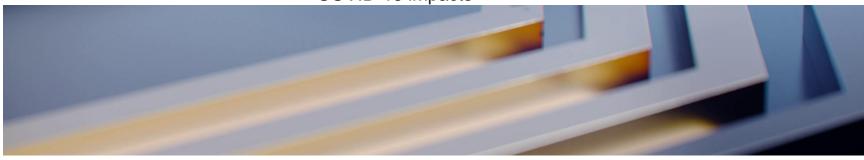
€1,188 mn

- Five year CAGR 8%
- Negative FX effects of € 37 mn

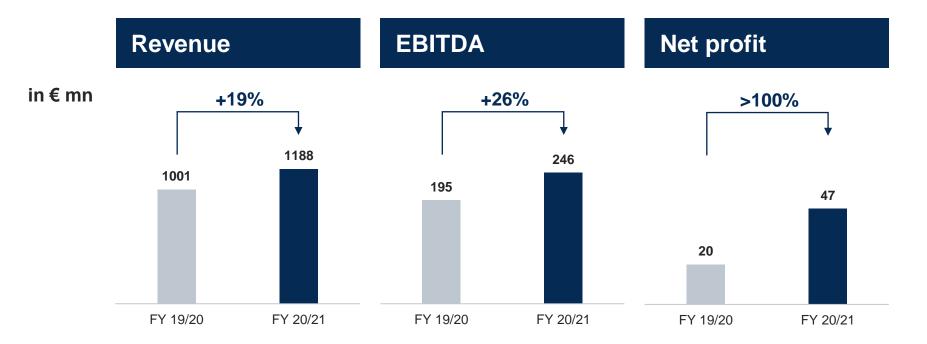
EBITDA margin **+130 bps** 

 Strong EBITDA margin despite headwinds from COVID-19 impacts ROCE +300 bps

 Driven by strong operating result

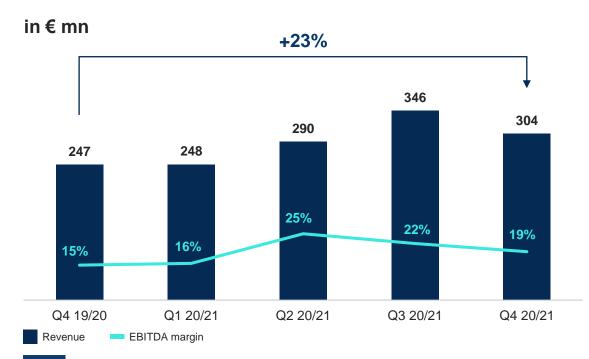


### FY 20/21 RESULTS SUMMARY





### **QUARTERLY DEVELOPMENT**



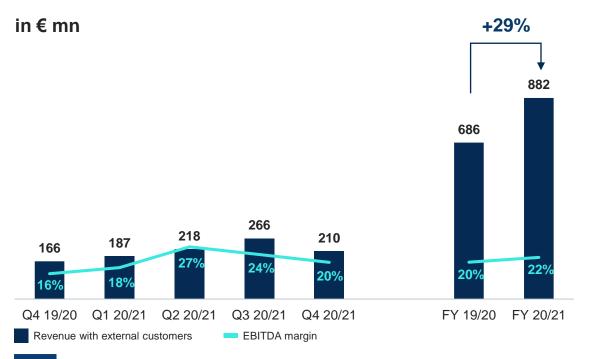
Highest Q4 revenue in history

Part of **seasonality mitigated** by growing IC substrates business

**Profitability** clearly improved

### **BUSINESS DEVELOPMENT**

#### **Mobile Devices & Substrates**



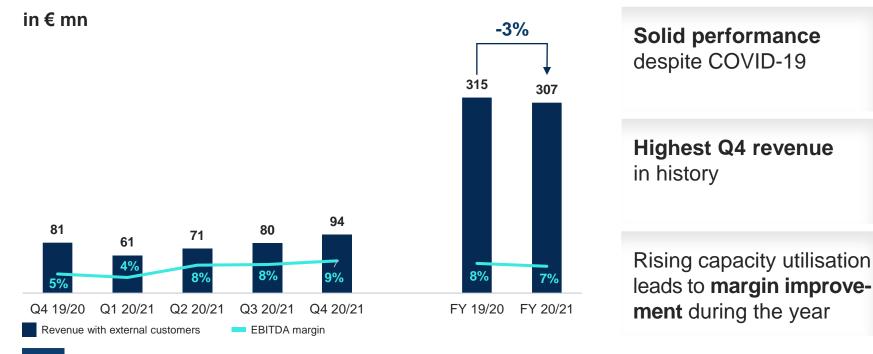
# Highest ever generated **business unit revenue**

Business unit revenue growth driven by **IC** substrates

# Growing demand for **PCBs for modules**

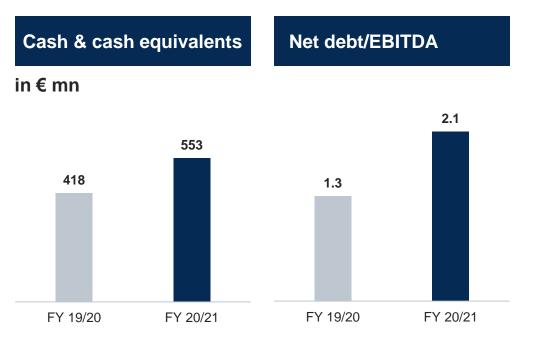
### **BUSINESS DEVELOPMENT**

#### Automotive, Industrial & Medical



### **FY 20/21 FINANCIAL POSITION**

Solid financial structure for future growth



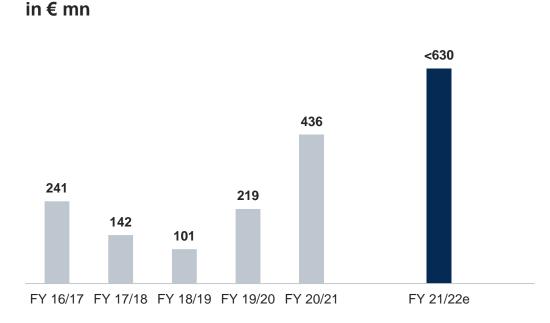
#### **Balancing capital allocation**

- Deploying capital with clear approach to invest in strategic growth markets
- Increasing net debt level by € 262 m in FY 20/21 due to investments in additional IC substrates capacities

Sound investment decisions to generate strong operating and free cash flow in the future.

#### **NET CAPEX**

#### Investments in IC substrates and module PCBs consistently continued



#### Capex outlook 2021/22

- Depending on market developments CAPEX for maintenance and tech upgrade of up to € 100 m
- CAPEX for strategic projects of up to € 450 m plus € 80 m due to timing variances

### **BALANCE SHEET**

| €mn          | 31.03.2020 | 31.03.2021 | Change in % |  |
|--------------|------------|------------|-------------|--|
| Total assets | 1,854      | 2,390      | +29%        | Ongoing expansion and<br>technology upgrades main driver<br>for increase in total assets |
| Equity       | 760        | 802        | +6%         |  |
| Equity ratio | 41%        | 34%        | -740bps     | Increase in total assets weighs on equity ratio  |
| Net debt     | 247        | 509        | >100%       | Higher CAPEX feeds into liquidity and drives up net debt                                 |





#### € mn

#### FY19/20 FY 20/21 Change in %

| CF from operating activities | 185  | 185  | -0.3%  | Stable as higher operating result is offset by higher working capital |
|------------------------------|------|------|--------|---|
| CF from investing activities | -117 | -340 | >-100% |   |
| CF from financing activities | 18   | 304  | >100%  |   |
| Operating free CF            | -33  | -251 | >-100% | Operating free CF mainly driven by higher CAPEX                       |



### GUIDANCE FY 21/22

Further growth ahead

| FY 21/22          |  |
|-------------------|--|
| Growth            | Revenue growth of 13 – 15%   |
| Profitability     | Adjusted EBITDA margin of 21 – 23%<br>Adjustment: start-up effects of the Chongqing project with an amount of appr. € 40 mn                      |
| CAPEX             | <ul> <li>Maintenance and tech-upgrades € 100 mn</li> <li>CAPEX from PY (timing variances) € 80 mn</li> <li>Expansion projects € 450 m</li> </ul> |
| Dividend proposal | € 0.39 per share (for FY 20/21)  |

### THANK YOU FOR YOUR ATTENTION



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